# Silicon Carbide Schottky Diode

# 650 V, 8 A

# FFSM0865B

Silicon Carbide (SiC) Schottky Diodes use a completely new technology that provides superior switching performance and higher reliability compared to Silicon. No reverse recovery current, temperature independent switching characteristics, and excellent thermal performance sets Silicon Carbide as the next generation of power semiconductor. System benefits include highest efficiency, faster operating frequency, increased power density, reduced EMI, and reduced system size and cost.

#### **Features**

- Max Junction Temperature 175°C
- Avalanche Rated 33 mJ
- High Surge Current Capacity
- Positive Temperature Coefficient
- Ease of Paralleling
- No Reverse Recovery / No Forward Recovery
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

#### **Applications**

- General Purpose
- SMPS, Solar Inverter, UPS
- Power Switching Circuits

# **MAXIMUM RATINGS** ( $T_C = 25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage		$V_{RRM}$	650	V
Single Pulse Avalanche Energy (starting $T_C = 25^{\circ}C$ , $I_{L(pk)} = 11.5$ A, $L = 0.5$ mH, $V = 50$ V)		E <sub>AS</sub>	33	mJ
Continuous Rectified Forward Current	T <sub>C</sub> < 153	Ιϝ	8.0	Α
Current	T <sub>C</sub> < 135		11.6	
Non-Repetitive Peak Forward	T <sub>C</sub> = 25°C	I <sub>FM</sub>	490	Α
Surge Current (t <sub>P</sub> = 10 μs)	T <sub>C</sub> = 150°C		434	
Non-Repetitive Forward Surge Current (Half-Sine Pulse)	$T_C = 25$ °C $t_P = 8.3$ ms	I <sub>FSM</sub>	42	Α
Power Dissipation	T <sub>C</sub> = 25°C	P <sub>tot</sub>	91	W
	T <sub>C</sub> = 150°C		15	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL RESISTANCE

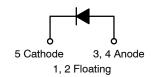
Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	1.64	°C/W



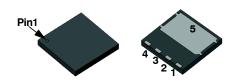
#### ON Semiconductor®

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V <sub>RRM</sub>	I <sub>F</sub>	
650 V	8.0 A	



#### **Schottky Diode**



PQFN 8×8, 2P CASE 483AP

## **MARKING DIAGRAM**

\$Y FFSM 0865B &Z&K&3

\$Y = ON Semiconductor Logo &Z = Assembly Plant Code &K = Lot Code

&K = Lot Code &3 = Numeric Date Code FFSM0865B = Specific Device Code

#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 2 of this data sheet.

## **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
N CHARAC	TERISTICS					
V <sub>F</sub>	Forward Voltage	I <sub>F</sub> = 8.0 A, T <sub>J</sub> = 25°C		1.39	1.7	V
		I <sub>F</sub> = 8.0 A, T <sub>J</sub> = 125°C		1.55		
		I <sub>F</sub> = 8.0 A, T <sub>J</sub> = 150°C		1.67		
I <sub>R</sub>	Reverse Current	V <sub>R</sub> = 650 V, T <sub>J</sub> = 25°C		0.5	40	μΑ
		V <sub>R</sub> = 650 V, T <sub>J</sub> = 125°C		1.0	80	
		V <sub>R</sub> = 650 V, T <sub>J</sub> = 175°C		2.0	160	
HARGES, C	APACITANCES & GATE RES	ISTANCE				
$Q_{C}$	Total Capacitive Charge	V <sub>C</sub> = 400 V		22		nC
C <sub>tot</sub>	1	V <sub>R</sub> = 1 V, f = 100 kHz		336		pF
		V <sub>R</sub> = 200 V, f = 100 kHz		39		1
		V <sub>R</sub> = 400 V, f = 100 kHz		30		1

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

#### PART MARKING AND ORDERING INFORMATION

Part Nu	mber	Top Mark	Package	Packing Method <sup>†</sup>	Quantity
FFSM0	865B	FFSM0865B	PQFN 8X8, 2P (Halogen Free)	Tape & Reel	3000 units

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# TYPICAL CHARACTERISTICS (T<sub>J</sub> = 25°C unless otherwise noted)

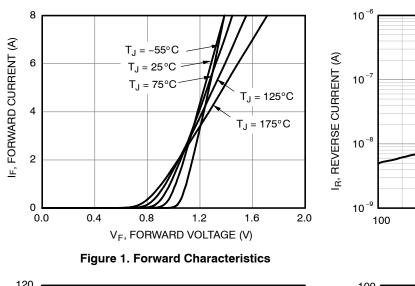
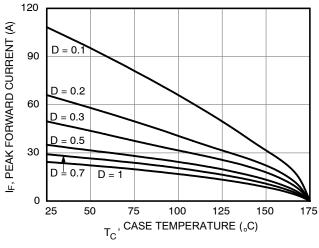


Figure 2. Reverse Characteristics



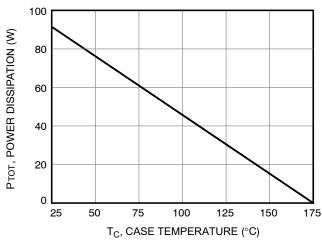
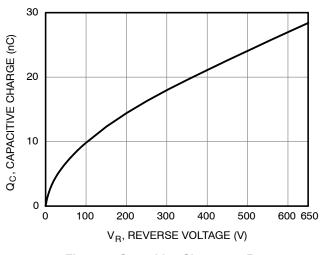


Figure 3. Current Derating

Figure 4. Power Derating



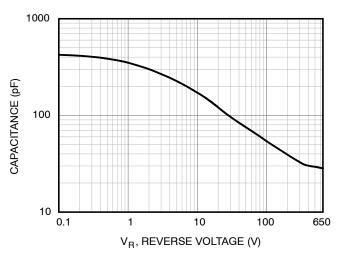


Figure 5. Capacitive Charge vs. Reverse Voltage

Figure 6. Capacitance vs. Reverse Voltage

# **TYPICAL CHARACTERISTICS** ( $T_J = 25^{\circ}C$ unless otherwise noted)

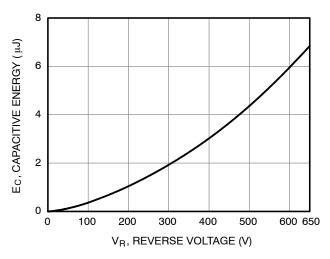


Figure 7. Capacitance Stored Energy

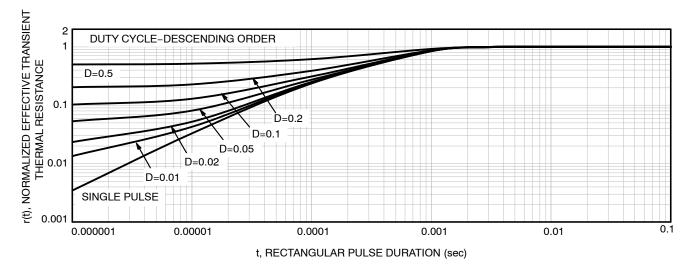
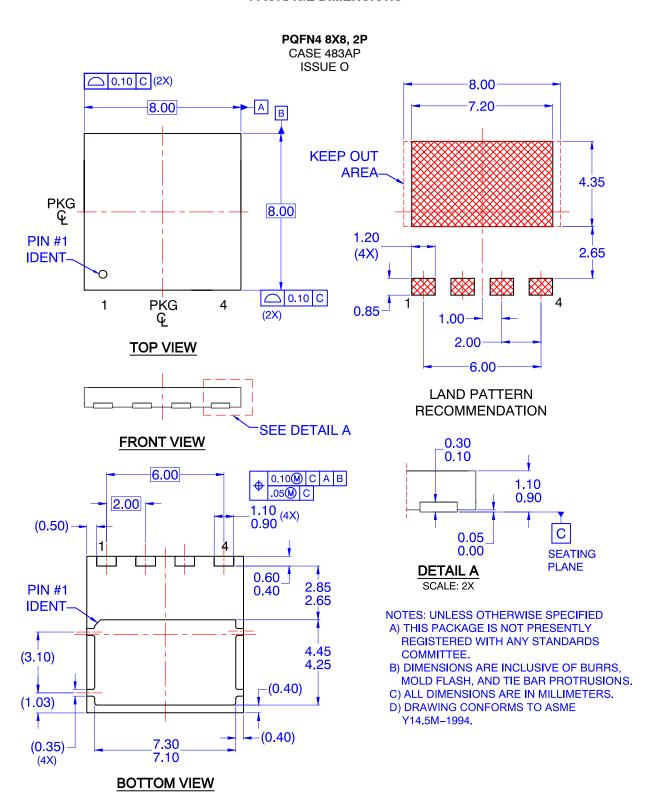


Figure 8. Junction-to-Case Transient Thermal Response

#### **PACKAGE DIMENSIONS**



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